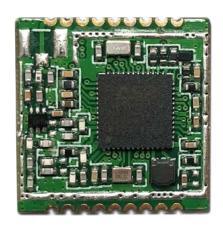




RFM6501W LoRaWAN Module Specification

General Description

The RFM6501W module is a SOC LoRaWAN module embedded with a Cypress 32-bit Cortex-M0+ low power MCU and a LoRa chip SX1262 of Semtech. It has ultra-low power consumption, high sensitivity, long distance communication and high performance. It integrates a wealth of peripherals, provides multiple general purpose IO, 32.768 kHz external crystal oscillator, channel interception, high precision RSSI, and 12-bit high-speed ADC input channel, etc.



Features

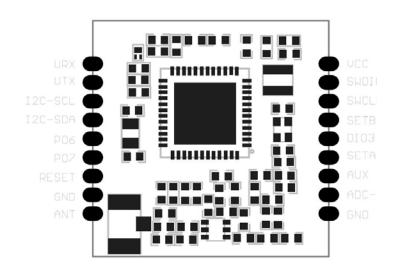
- Ultra strong capacity of resisting disturbance, suitable for complex interference environment scenarios
- Receiving sensitivity: -137dBm SF=12\, BW=125KHz
- Working Frequency: 470MHz、868MHz、 915MHz
- Supply Voltage: 2.4V-3.7V
- Transmit Current: 107mA +22dbm 470MHz
- Receiver Current: 9mA 470MHz

Applications

- LoRaWAN End Node
- Smart Meter Reading
- Building Automation
- Remote Control Application
- Security System
- Smart Parking
- Smart City
- Environmental Monitoring
- Supply Chain and Logistics

Ordering Information

Model No.	Working Frequency		
RFM6501W-470S2	470MHz		
RFM6501W-868S2	868MHz		
RFM6501W-915S2	915MHz		



Pic1. RFM6501W Front View



Module Pin Information

Table 1. RFM 6501 Module pin definition

Pin No	Pin Name	Description				
1	URX	UART RX				
2	UTX	UART TX				
3	I2C-SCL	12C-SCL				
4	12C-SDA	I2C-SDA				
5	P06	UART CTS, also be used as an external 24MHz crystal input.				
6	P07	UART RTS, also be used as an external 24MHz crystal output.				
7	RESET	External Reset Control Port				
8	GND	Ground				
9	ANT	Antenna input and output ports				
10	VCC	Power- supply				
11	SWDIO	SWDIO Data				
12	SWCLK	SWCLK Clock				
13	SETB	MCU GPIO				
14	DIO3	Multipurpose digital I/O, not used as external GPIO				
15	SETA	MCU GPIO				
16	AUX	MCU GPIO				
17	ADC-IN	ADC Input				
18	GND	Ground				

Notes:

- 1 The chip ASRF6501's Pin 35 MISO and Pin 20 have been externally connected.
- 2 The chip ASRF6501's Pin 36 MISO and Pin 19 have been externally connected.
- 3 The chip ASRF6501's Pin 37 SCK and Pin 21 have been externally connected.
- 4 The chip ASRF6501's Pin 39NSS and Pin 22 have been externally connected.



Electrical Parameters

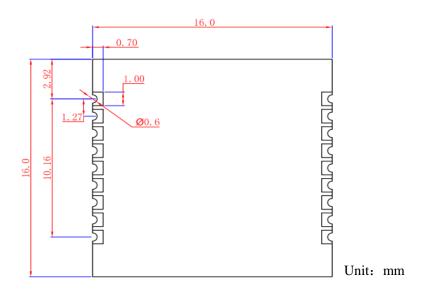
Testing Conditions: Power Supply 3.3V, Temperature 25°C

Table2. Electrical Parameters

Parameters	Symb ol	Condition	Min	Typical	Max	Unit
Working Frequency	Fc	RFM6501-470S2		470		MHz
		RFM6501-868S2		868		MHz
		RFM6501-915S2		915		MHz
Receiving Sensitivity	S	LORA:SF=12 BW=125KHz		-137		dBm
		LORA:SF=12 BW=125KHz		-137		dBm
		LORA:SF=12 BW=125KHz		-137		dBm
Working Voltage	V_{DD}		2.4	3.3	3.7	V
Receiving Current	Irx	470MHZ		9	10	mA
		868MHZ		9	10	mA
		915MHZ		9	10	mA
Transmitting Current	I _{Tx}	470MHZ +22dbm		107	120	mA
		868MHZ +22dbm		118	130	mA
		915MHZ +22dbm		118	130	mA
Sleeping Current	Sleep	No RF & No RTC		2	3	uA
Working Temperature	Тор		-40		+85	°C



Module Outline Dimension Diagram



Pic2. Module Dimension Diagram

HOPEMICROELECTRONICS CO.,LTD Add:2/F,Building3,pingshan Private Enterprise science and Technology Park,xili Town,Nanshan District, Shenzhen, China

Tel: 86-755-82973805
Fax: 86-755-82973550
Email: sales@hoperf.com
Website: http://www.hoperf.com

http://www.hoperf.cn

This document may contain preliminary information and is subject to change by Hope Microelectronics without notice. Hope Microelectronics assumes no responsibility or liability for any use of the information contained herein. Nothing in this document shall operate as an express or implied license or indemnity under the intellectual property rights of Hope Microelectronics or third parties. The products described in this document are not intended for use in implantation or other direct life support applications where malfunction may result in the direct physical harm or injury to persons.

NO WARRANTIES OF ANY KIND, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIESOF

MECHANTABILITYORFITNESSFORAARTICULARPURPOSE,AREOFFEREDIN THISDOCUMENT.

© 2019, HOPEMICROELECTRONICSCO.,LTD. All rights reserved.